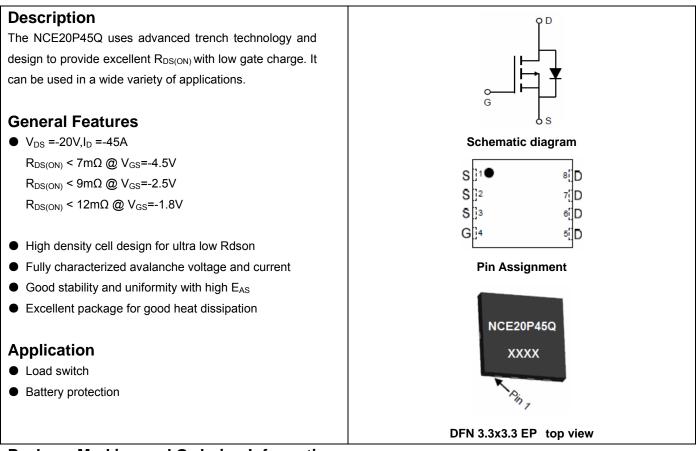


# NCE P-Channel Enhancement Mode Power MOSFET



#### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE20P45Q	NCE20P45Q	DFN 3.3x3.3 EP	-	-	-

## Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-20	V
Gate-Source Voltage	Vgs	±10	V
Drain Current-Continuous	Ι <sub>D</sub>	-45	А
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	-35	А
Pulsed Drain Current	I <sub>DM</sub>	-200	A
Maximum Power Dissipation	P <sub>D</sub>	80	W
Derating factor		0.64	W/℃
Operating Junction and Storage Temperature Range	$T_{J},T_{STG}$	-55 To 150	°C

## **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	$R_{ extsf{ heta}JC}$	1.6	°C/W
	000		





## Electrical Characteristics (T\_c=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	·	·		•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-20	-	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250µA	-0.4	-0.6	-1.0	V	
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-20A	-	5.8	7	mΩ	
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-20A	-	7.2	9		
		V <sub>GS</sub> =-1.8V, I <sub>D</sub> =-20A		9	12		
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-5V,I <sub>D</sub> =-20A	80	-	-	S	
Dynamic Characteristics (Note4)	<b>I</b>						
Input Capacitance	C <sub>lss</sub>		-	3500	-	PF	
Output Capacitance	C <sub>oss</sub>		-	577	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0WHZ	-	445	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t <sub>d(on)</sub>		-	18	-	nS	
Turn-on Rise Time	tr	$V_{DD}$ =-10V, $R_{GEN}$ =3 $\Omega$	-	42	-	nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}=-4.5V, I_{D}=-20A$ $V_{GS}=-2.5V, I_{D}=-20A$ $V_{GS}=-1.8V, I_{D}=-20A$ $V_{DS}=-5V, I_{D}=-20A$ $V_{DS}=-10V, V_{GS}=0V,$ F=1.0MHz $V_{DD}=-10V, R_{GEN}=3\Omega$ $V_{GS}=-4.5V, R_{L}=0.5\Omega$ $V_{DS}=-10V, I_{D}=-20A,$ $V_{GS}=-4.5V$ $V_{GS}=-4.5V$ $V_{GS}=-4.5V$	-	85	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	23	-	nS	
Total Gate Charge	Qg	V 40V/L 00A	-	55	-	nC	
Gate-Source Charge	Q <sub>gs</sub>		-	10	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =-4.5V	-	15	-	nC	
Drain-Source Diode Characteristics			•				
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-20A	-	-	-1.2	V	
Diode Forward Current (Note 2)	I <sub>S</sub>		-	-	-45	Α	
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = -10A	-	47	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3)	-	53	-	nC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LE					

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.

**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production



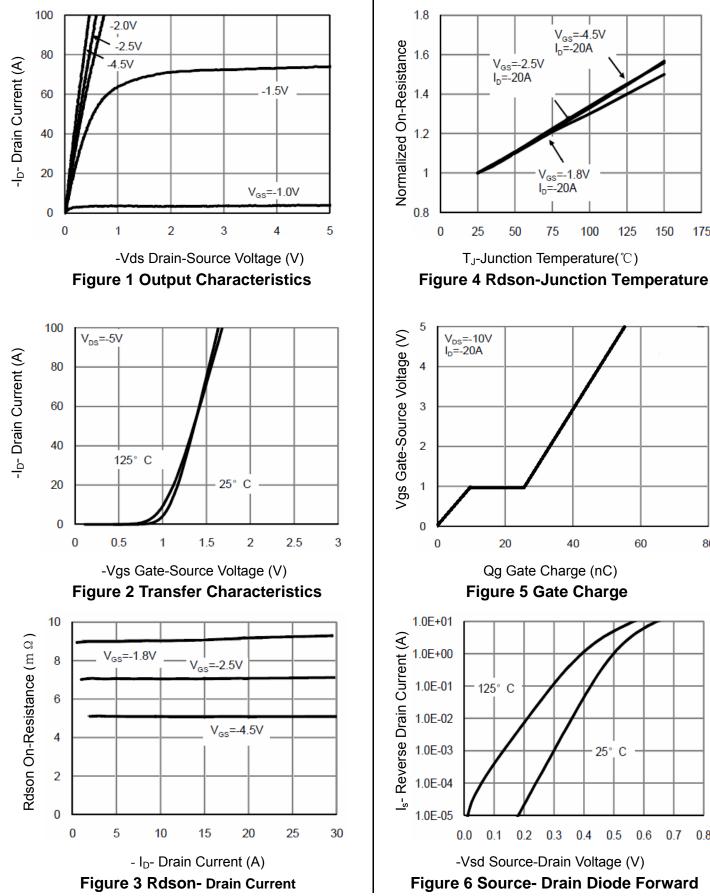




175

80

## **Typical Electrical and Thermal Characteristics (Curves)**



0.8

0.7



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Pb Free Product

NCE20P45Q

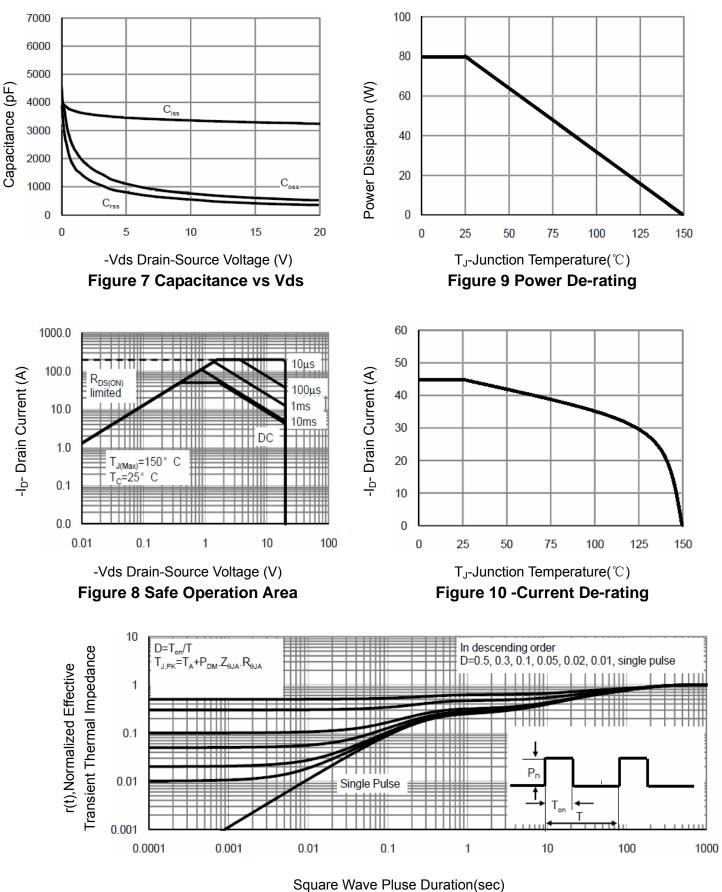


Figure 11 Normalized Maximum Transient Thermal Impedance



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# DFN3.3X3.3 EP Package Information

封装外形尺寸图				
	符号	单位: ㎜		
╆╎╶╼┽┾╾ <sup>╸</sup> ┿┼╼╌┝┥┍┐┍┐╵┵		MIN	MAX	TYP
۴ t	A	0.75	0.85	0.8
	В	0.25	0.35	0.3
<b>⊢</b>	с	0.18	0. 22	0.2
	D	3. 2	3. 3	3. 25
	E	3. 2	3. 3	3. 25
	F	2.2	2.5	2. 35
	G	1.8	2.0	1.9
	н	0.3	0.4	<mark>0.</mark> 35
	I	0.15	0.25	0.2
	J	0.4	0.5	0.45
⊥ ⊢ <del>−</del> <sup>┏</sup> −≠┤	K	0.6	0.7	0.65
	L	1.38	1.58	1.48
	М	1.8	2.1	1.95
	N	0.15*45°		
	0	0.4	0.5	0.45



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